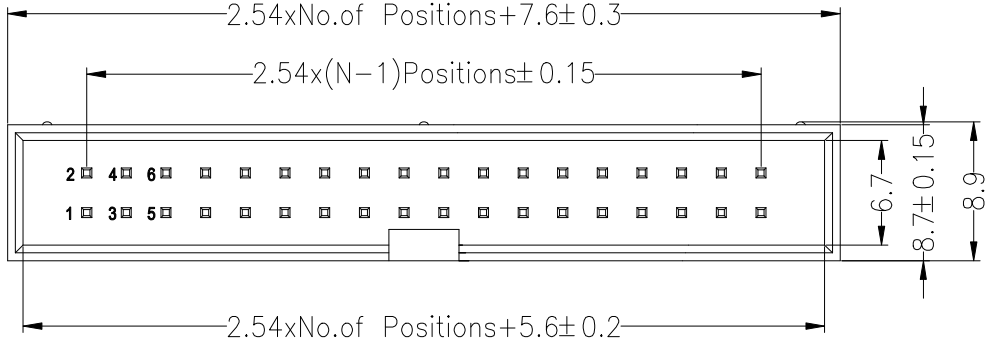
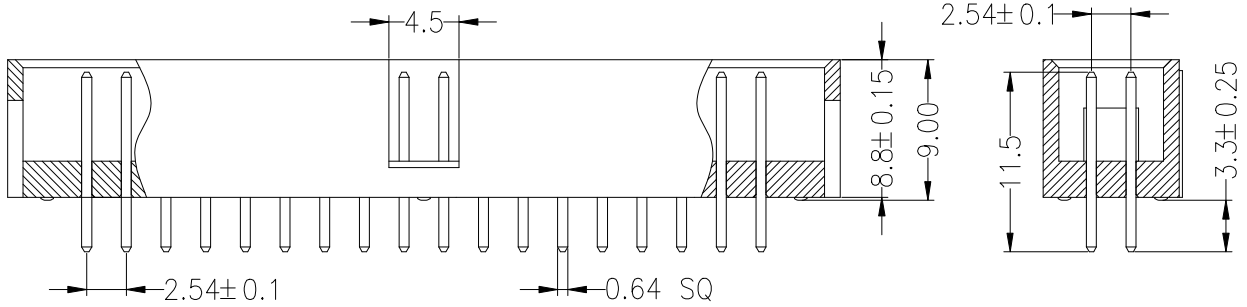
HSF RoHS FILE NO :E362810

SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PBT
Max.Processing Temp: 200°C for 30−60 seconds
(230°C for 10 seconds)

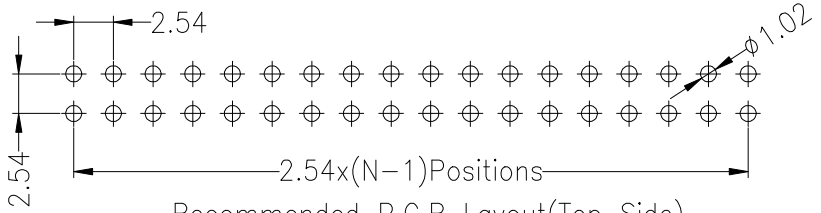




Ordering Information

3210 XX S XX A B K00 X 0X

- No.of Pins: 6−−64
- Contact Plating: G0:Gold Flash; G1:1U" Gold; G2:1.5U" Gold; G3:2U" Gold; G4:3U" Gold; G5:5U" Gold; G6:10U" Gold; G7:15U" Gold; S0:Gold Flash/Tin; SN:Tin
- Insulator Material Option: A=PBT; C=PA6T; E=PA9T; F=LCP
- Packing: T=Tube; A=Tray; P=Tube+Cap



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE± 0.05)

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2019.09.21	NEW DRAWING	

OPERATION		DRAW	Liu Miao	19.09.21	SCALE	FIT
X.X	± 0.30				UNIT	mm
X.XX	± 0.20	CHECK			SIZE	A4
X.XXX	± 0.10				SHEET	1/1
Angle	± 3°	APPROVE			PROJ.	
DIM	TOL					

WFD CONN 深圳市旺富达电子有限公司 SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	3210XXSXXABK00X0X
TITLE:	2.54mm Box Header H8.8mm 180°